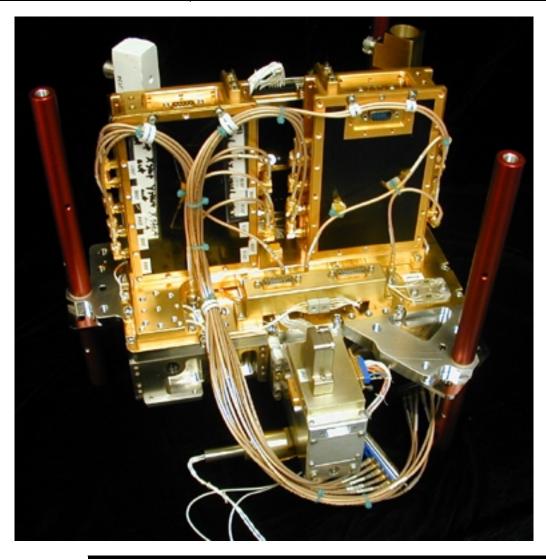


HST COS FUV DETECTOR SYSTEM P.E.R.



HST-COS

FUV Detector
Pre-Environmental
Review

November 8th 2000



Order of Presentation



Siegmund PER Introduction/System Overview

FUV System Specification/Description Overview

FUV System Overview of Assemblies (DEB, DVA) + acronyms

System Block Diagram Mass Budget Status Power Budget Status Power Application Matrix

FUV Electronic Board Status DVA Status by sub-assembly:

BBA status

VHA status HVFM Status

Amplifier Status

DEB Status to-date by sub-assembly:

LVPC Status HVPS Status

DCE Status ACTEL Status

Gaines Electronics Board Qualification Status

Unit Test Summaries

Amplifiers DCEs TDCs

Unit Cleanliness Status Matrix

Power Systems Harnesses

Scholz Quality Assurance

Document Flowdown chart FUV Documentation Status

CM Overview

ECs Changes to System since Mission CDR

MOs PFRs

Waivers

war

Close-out/Open Items



Order of Presentation, ctd



Donakowski Mechanical Analysis

Materials Fracture Control Stress analysis

McPhate Performance Verification

FUV Performance Verification Matrix

FUV Detector Performance Requirements (SOR)

Performance Test Flow Spatial Resolution Spatial Linearity Image Stability Deadtime Dark Count

QΕ

DVA Metrology Plan

Welsh FUV System Environmental Qualification Overview

Overall FUV system test plan flow

Detector Functional (short and long) test description

Environmental Test Plan

Vibration Test Plan

EMI/EMC

Themal/Vacuum Testing

Cleanliness Cert

Environmental Test Matrix FUV System Shipping Plan

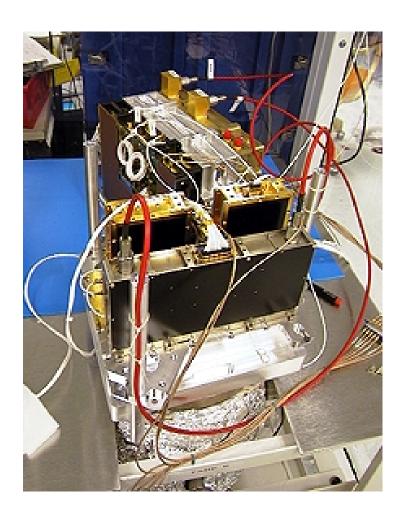


HST COS FUV DETECTOR SYSTEM P.E.R.



FUV Detector System Introduction and Overview

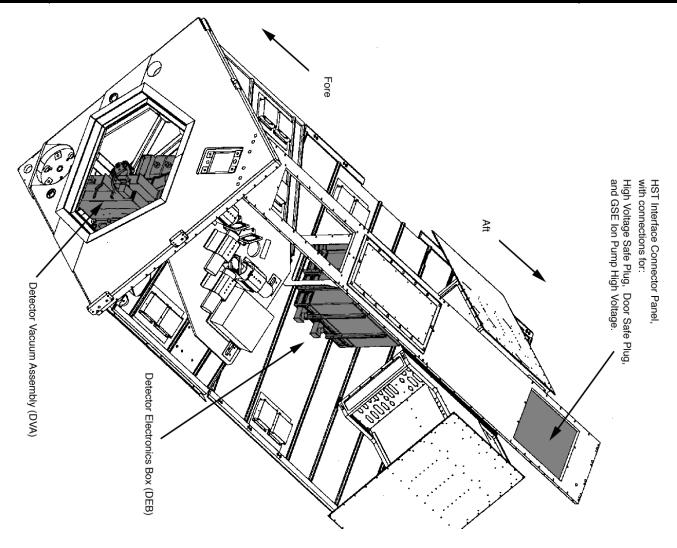
Dr. Oswald Siegmund





FUV DETECTOR IN COS SPECTROGRAPH



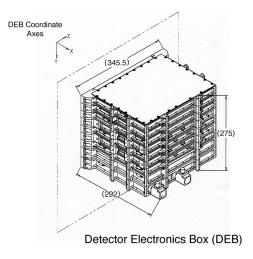


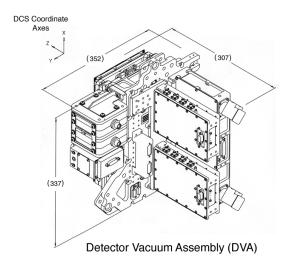


OVERVIEW OF FUV ASSEMBLIES



- **DEB** (**D**etector **E**lectronics **B**ox)
 - DCE (Detector Control Electronics))
 - TDCs (Time-to-Digital Converters)
 - HVPS (High Voltage Power Supply)
 - LVPC(Low Voltage Power Converter)
- **DVA** (**D**etector **V**acuum **A**ssembly)
 - VHA (Vacuum Housing Assembly)
 - DBA (Detector Backplate Assembly)
 - Amplifiers
 - HVFM (High Voltage Filter Module)







COS FUV System Configuration Features

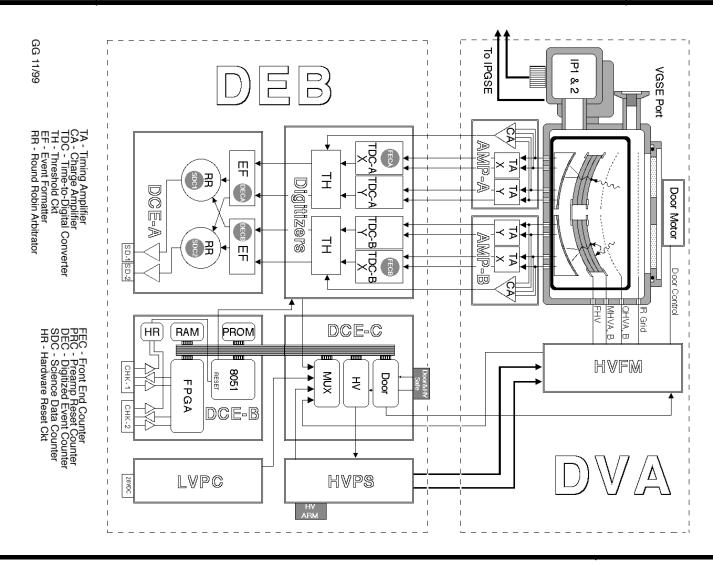


- Dual segment, delay line microchannel plate detector scheme
 - 2 segments per detector, <9mm gap, 179 x 10mm overall active area
 - MCP front surface curved to 0.826m focal radius
 - Detection Efficiency optimized from 1000Å to 2500Å with CsI photocathode
- Self-contained vacuum system
 - Flight GSE Ion Pumps
 - Flight operable door with motor drive and backup actuator release mechanism
- 8051 Microcontroller
 - Automation and self-protection of HV and Door Operations
 - Global Count Rate Protection



FUV DETECTOR SYSTEM BLOCK DIAGRAM







FUV Detector Mass Budget



COS FUV DetectorS ystem M ass Bud get Report UC B-COS-RP T-1004 Re v si on C

| RI | EV DATE | DESCRIP TION | AP P RVAL |
|----|----------|---|-----------|
| - | 4/29/99 | Base Inie Re dease | Ga ines |
| A | 4/ 17/99 | Upda t with me aur ments | Ga nies |
| В | 7/ 23/00 | Upda t D B SOR Al oc ai on from 12 7 to 15.3 kg | Ga ines |
| C | 11 4/00 | Upda t with me sur enents, se parat cout cov es | Ganies |

| D V A | Mass K(g) | N de s |
|-----------------------------|-----------|---------------------|
| VacumuHouinsg A sembly | 10.13 | Mea s re d(Flight) |
| Dtector DooreMhaisam | - | (In kuded in VHA) |
| Io nPump Asem bly | - | (In kuded in VHA) |
| Detect or Backlapte | 5.04 | Mea s re d(Flight) |
| Hetasink sAstembly | 1.66 | Mea s re d(Flig h)t |
| Amplifier U rits (2) | 1.25 | Mea s re d(ET U) |
| H Wilter M o dla | 1.52 | Mea s re d(Flight) |
| Baffle s Mag ntiæ Sheldetc. | 0.8 | Estimate |
| T dal DV A | 20.43 | |

| D FB | Mass K(g) | N de s |
|-------------------|-----------|--------------------|
| DŒ | 3.06 | Mea s re d(Flight) |
| TD C (4) | 4.96 | Mea s re d(Flight) |
| H VPS | 2.08 | Mea s re d(Flight) |
| LV PC | 2.14 | Mea s re d(Flight) |
| Inte ior Co v is | 1.20 | Mea s re d(Flight) |
| Ex terior Co v rs | 1.00 | Estimate |
| T dal DE B | 14.44 | |

| FU VSyst em | Mass K(g) | SOR Moction1 (Kg) | Marig(%) |
|-------------------------------|-----------|-------------------|----------|
| D V A | 20.43 | 21.5 | 5.2 |
| D FB | 14.44 | 15.3 | 6.0 |
| H arn ess/C a bing | 2.7 (e s) | 3.4 | 25.9 |
| T dal FU VD de do r Sy dem | 37.57 | 40.2 | 7.0 |

N OTES: 1. The SOR is COS-08-00B & VB State metrof Req ir e reants for the HST/COSF W Dete do r.

Change to mass prortipes to be repreted in COS monthlies, a mind reission sto this report



FUV Power Budget



COS FUV Detecto rS ystem P ove rBud get Report UC BCOS-RP T-1015 Re vsi on D

| REV | DATE DESCRIP TON | RE IORT IR |
|-----|---------------------------------------|------------|
| - | 4/ 2/99 Base Inic Re drase | Ga nies |
| A | 4/ 17/00 Upda t with me aur d va ules | Ga nies |
| В | 10 19/00 Upda t with me aur d va ules | Ga nies |
| C | 10 24/00 Corr et minor cl ei al error | Ga nies |
| D | 11 4//00 Reduc ePower 2. 7W by E @052 | Ga nies |

| D V A | Ope r tao n laP o wr (W ats) | N de s |
|---------------------------|---------------------------------|------------------------|
| Detect or Doored Ministra | 4.0 | Mea s noe d(FUSE) |
| Amplifier U nits (2) | 3.88 | Mea s ne d(COS Flight) |
| H VFilter M o dea | 0.71 | Mea s ne d(COS Flight) |
| T dal DV A | 4.59 ¹ | |

| D IB | Ope r tao n laP o var (W ats) | N de s |
|------------|----------------------------------|-------------------------------------|
| D Œ | 4.09 | Mea s næ d(COS Flight) |
| TD C (4) | 28.32 | Mea s ne d(COS Flight) ² |
| H VPS | 3.52 | Mea s ne d(COS Flight) |
| LV IC | 11.49³ | Mea s ne d(COS Flight) |
| T dal DE B | 47.42 | |

| FU VSyst en | ICD Estim ae | Mesair el Powe | r SOR ⁴ All c ca ton | Maning(%) |
|------------------|--------------|----------------|--|-----------|
| | (4/2 2 / 9 9 | (W ats) | (W ats) | |
| D V A | 5.7 | 4.59 | | |
| D IB | 43.7 | 47.42 | | |
| T dal FU V | 49.4 | 52.01 | 53.0 | 1.73 |
| D te to rS ste m | | 0 = 1, 0 = | | |

N CTES:

- 1. Detect or Do o recMi aism powren toincl ueth sin cet is powedronly on cine flight.
- 2. Po wiere d u c fer don me a sready dau eb y .72 Wby ECO 0 5 2.
- 3. Bas e d me sure dLVPC e ficie n cof 7 % a nomin a lo a d
- 4. The SOR is COS-08 00 Strate met of Require nonts for the HST/COSF UV Detector

Accumulated Run Times (hours)

| Subassembly | Set 1 | Set 2 |
|-------------|-------|-------|
| Amplifiers | 1026 | 985 |
| DCE | 807 | 728 |
| LVPC | 437 | 6 |
| TDCs | 232 | 1 |
| HVPS | 175 | 1 |
| HVFM | 6 | 1 |



Changes to System Since Mission CDR



• DCE

- 8051 clock changed from 16 Mhz to 8 Mhz to add timing margin for (slower) flight ACTEL (per Baja)
- Power-On-Reset circuit enhancement for extra margin, increased SEU tolerance (per I. Orlowski)

TDC

Minor TDC-Y ACTEL modifications per Mark Voyton of GSFC

• Flight Software

- 8051 controller BOOT code simplified, re-written
- Flight OPERATE code currently being re-written and tested on ETU DEB. One week added to schedule for system test in vacuum prior to Vibration Test.
- GSE OPERATE code mature and under Level II configuration control since June 2000. Environmental tests to be performed with this code.
- FSW to be reviewed by the COS project in separate review



UCB FUV Detector - Flight BBA Status



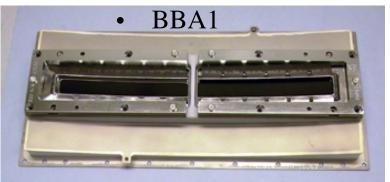
- Brazed Body Assemblies have 3 flight BBA units
- MC° P's have 11 flight MCP sets
- Performance
 - Resolution, is the primary selection criteria, ~ 25μm for most MCP stacks.
 - Flat field MCP multifiber dominates, some small dead spots, & edge Moire
 - Background almost all MCP sets have good background <0.5 events cm⁻² s⁻¹
 - PHD all MCP sets have good PHD's $\sim 35\%$ 60% FWHM @ $\sim 10^7$ gain
 - Gain map adjusted by shims to make uniform
 - Mini-scrub extract 0.02 C cm⁻² to assess gain stabilization effects
 - Metrology need to match focus curve to ±100μm
- Repeatability
 - Repeated MCP stackings give very consistent results
 - BBA's give same results on different DBA's with different anodes



UCB FUV Detector - Flight BBA Status



- BBA #1 rebuilt with new MCP's. Resolution, tests show good (<25μm) performance. Doing gain map, flat field, background tests, mini-scrub next.
- BBA #2 mini scrub, background tests & gain trim done. Flight TDC flat field, resolution (<25µm) & functional tests are good. Selected for flight detector. Metrology with DBA#1 & shimming being completed. Formal verification tests imminent.
- BBA #3 assembled with new MCP's. Resolution, functional and background tests underway.



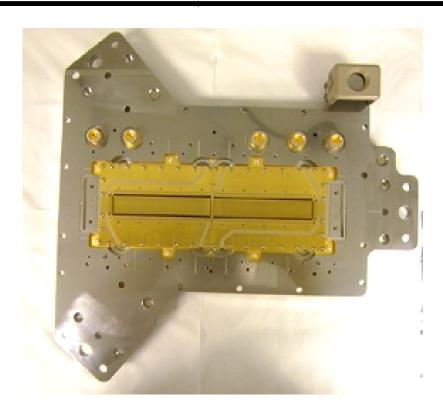




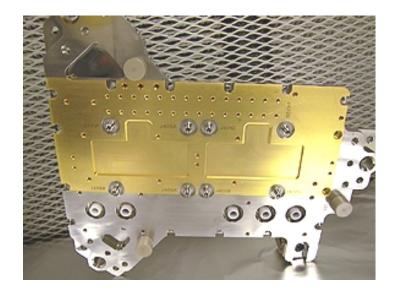


Backplate Status





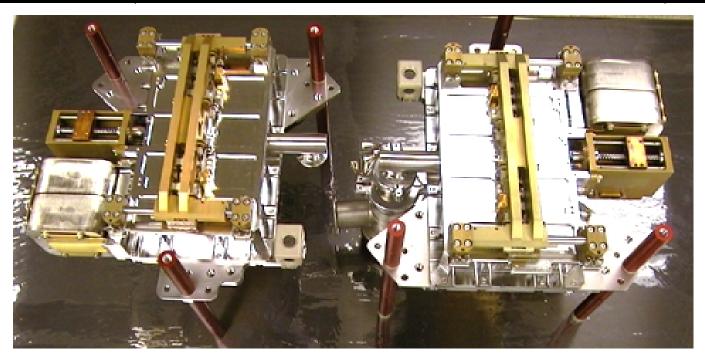
- DBA #1 integrated with 2 flight anodes and BBA#2 in flight detector (in metrology)
- DBA #2 with 2 flight anodes & cradle ready to be integrated BBA#1
- DBA #3 in test on VHA





Detector Vacuum Assembly





- Two VHA units assembled and attached to DBA's
- VHA #1 and #2 vacuum verified and operated with ion pumps
- VHA #1 and #2 door operation verified
- VHA's ready for detector integration



FUV Electronic Board Status



| ACTIVITY | Amps | TDC-X | TDC-Y | HVFM | HVPS | LVPC | DCE-A | DCE-B | DCE-C |
|---------------------------------|----------|-------|-------|----------|--------------|----------|-------|-------|--------------|
| Parts List | С | С | С | С | С | С | С | С | С |
| Schematic | С | С | С | С | С | С | С | С | С |
| Actel Work | | _ | _ | _ | <u> </u> | | _ | _ | |
| Initial Design | NA | C | C | NA | NA | NA | C | C | NA |
| Actel Peer Review | NA NA | C | C | NA NA | NA NA | NA NA | C | C | NA NA |
| End-to-End Simulation | NA NA | C | C | NA NA | NA NA | NA NA | C | C | NA NA |
| GSFC Review | NA NA | C | C | NA NA | NA NA | NA NA | C | C | NA NA |
| FPGA tests with ETU electronics | NA NA | C | C | NA NA | NA NA | NA NA | C | C | NA NA |
| Release ACTEL Schematic | NA | Ĉ | C | NA NA | NA | NA NA | C | Č | NA NA |
| | | | | | | | | | |
| PC Board Layout | С | С | С | С | С | С | С | С | С |
| Parts Stress Analysis | С | С | С | NA | NA | NA | NA | С | С |
| Worst Case Analysis | NA | С | С | NA | NA | С | NA | С | С |
| Board Thermal Analysis | С | С | С | S | S | S | С | С | С |
| Release Layout | С | С | С | С | С | С | С | С | С |
| Board Fabrication | С | С | С | С | С | С | С | С | С |
| Kit Parts | С | С | С | С | С | С | С | С | С |
| Board Coupon Testing | С | С | С | С | С | С | С | С | С |
| Stuff PC Boards | С | С | С | С | С | С | С | С | С |
| Board Workmanship Acceptance | С | С | С | С | С | С | С | С | С |
| Board Engineering Acceptance | С | С | С | С | С | С | С | С | С |
| Engineering Test & Acceptance | С | С | С | С | С | С | С | С | С |
| Temperature Cycle Test | С | S | S | С | С | С | С | С | С |
| Voltage Margin Test | С | С | С | NA | NA | NA | С | С | С |
| Final Acceptance Test | С | | | С | С | С | С | С | С |
| Clean & Conformal Coat | С | | | С | С | С | | | |
| | | | | | | | | | |

C = Complete

NA = Not Applicable

S= started



FUV Detector Electronics Verification & Status Summary

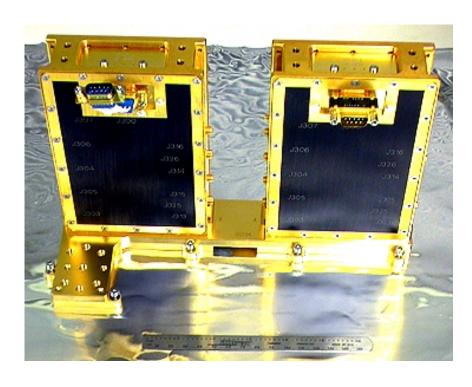


- Amplifiers Ready for final integration
- HVFMs Ready for final integration
- HVPS conformally coated ready for final integration
- LVPC conformally coated ready for final integration
- DCEs POR enhancements under test, conformal coat pending PROM burn
- TDCs in thermal testing



Amplifier Status



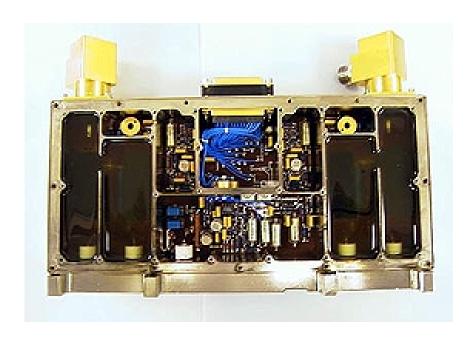


- Four Flight Amplifiers PCBs stuffed and mounted in frames.
- Stuffed by J&T and initial workmanship QA inspection done.
- Protection diodes and noise filters applied at UCB.
- Passed GSFC inspection
- Electronic performance verified
- Voltage margin testing completed
- Thermal cycle tests completed
- Cleaned, conformally coated, staked and baked.
- Four units ready for integration



HVFM Status



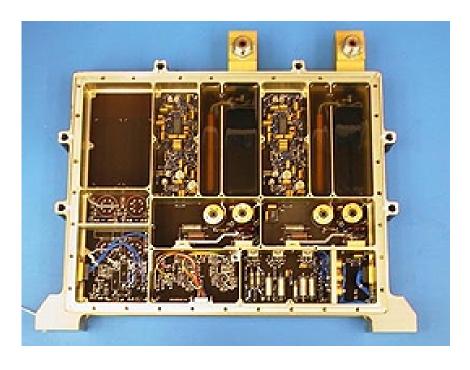


- 2 Flight HVFM units received from Battel Engineering
- Passed QA inspection by GSFC
- Engineering Acceptance done at UCB
- Electronic performance verified
- Thermal cycle tests completed
- Cleaned, conformally coated, potted
- Initial four day vacuum bake-out of EN-11 potting material at 60°C & TQCM measured
- Two units ready for integration



HVPS Status





- 2 Flight HVPS units Received from Battel Engineering
- Passed by GSFC QA
- Passed UCB incoming inspection
- Engineering Acceptance tests done
- Electronic performance verified
- Thermal cycle tests completed
- Initial four day vacuum bake-out of EN-11 potting material at 60°C & TQCM measured
- One unit in use on flight detector
- One unit being cleaned, staked, and conformally coated at Lockheed



LVPC Status



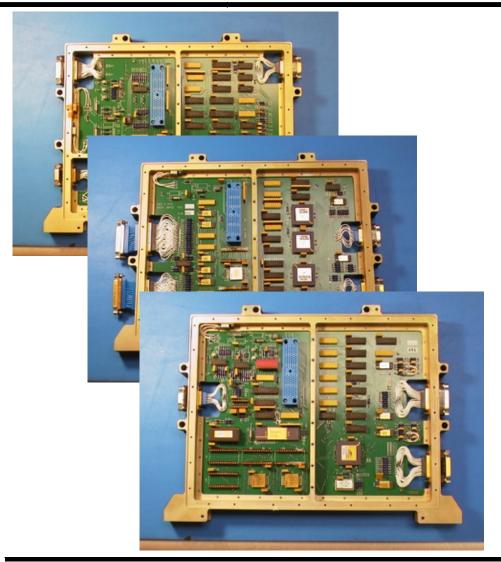


- Two flight LVPC units received from Battel Engineering
- Passed UCB incoming inspection
- Passed GSFC QA
- Engineering Acceptance tests completed
- Thermal tests performed by Battel Engineering
- Cleaning and conformal coating at Lockheed this week



DCE Status



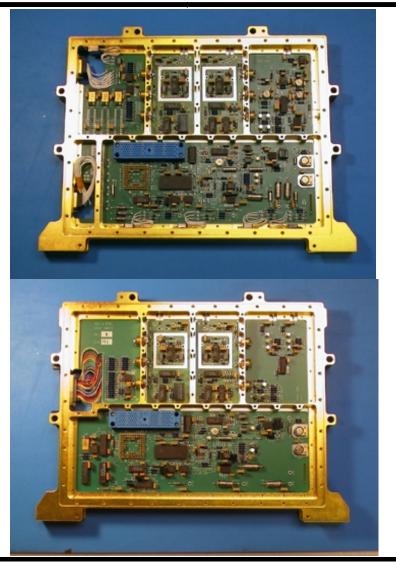


- Received flight DCE boards from J&T (2 sets of 3 (A, B, C.))
- Passed UCB inspection & GSFC QA
- Thermal analysis performed by BATC
- Engineering Acceptance tests done
- Electronic performance verified
- DCE ACTEL designs reviewed by GSFC.
- Voltage margin tests completed
- Frequency margin tests completed
- Thermal cycle tests completed
- One set in use on flight detector
- One set having POR modifications applied and tested.



TDC Status





- 4 sets of X & Y Flight TDC units received from J&T
- Passed QA inspection by GSFC
- Thermal analysis performed by BATC
- Engineering Acceptance done at UCB
- Electronic performance verified with BBA#2 flight detector
- TDC ACTEL designs under review
- One ACTEL set burned and under test
- Voltage margin tests complete
- Frequency margin tests complete
- Thermal cycle tests underway on 1st set
- One set in use on flight detector